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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/605,968	11/10/2003	Chin-Lung Lin	NAUP0543USA	2967
27765	27765 7590 03/10/2006		EXAMINER	
NORTH AMERICA INTELLECTUAL PROPERTY CORPORATION P.O. BOX 506 MERRIFIELD, VA 22116			CHACKO DAVIS, DABORAH	
			ART UNIT	PAPER NUMBER
			1756	

DATE MAILED: 03/10/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

			20
		Application No.	Applicant(s)
		10/605,968	LIN ET AL.
	Office Action Summary	Examiner	Art Unit
		Daborah Chacko-Davis	1756
Period f	The MAILING DATE of this communication apports or Reply	pears on the cover sheet with the	correspondence address
WHI - Exte afte - If No - Fail Any	HORTENED STATUTORY PERIOD FOR REPL CHEVER IS LONGER, FROM THE MAILING D ensions of time may be available under the provisions of 37 CFR 1.1 r SIX (6) MONTHS from the mailing date of this communication. O period for reply is specified above, the maximum statutory period ure to reply within the set or extended period for reply will, by statute reply received by the Office later than three months after the mailing patent term adjustment. See 37 CFR 1.704(b).	PATE OF THIS COMMUNICATION 136(a). In no event, however, may a reply be will apply and will expire SIX (6) MONTHS from the cause the application to become ABANDON	ON. timely filed om the mailing date of this communication. NED (35 U.S.C. § 133).
Status			
1)⊠ 2a)⊟ 3)⊟	Responsive to communication(s) filed on 10 N This action is FINAL . 2b) This Since this application is in condition for allowa closed in accordance with the practice under B	s action is non-final. ince except for formal matters, p	
	·	ex parte quayre, 1005 C.D. 11,	430 0.6. 210.
4)⊠ 5)□ 6)⊠ 7)□ 8)□	Claim(s) 1-20 is/are pending in the application 4a) Of the above claim(s) is/are withdra Claim(s) is/are allowed. Claim(s) 1-20 is/are rejected. Claim(s) is/are objected to. Claim(s) are subject to restriction and/o tion Papers The specification is objected to by the Examine	wn from consideration. or election requirement.	
	The drawing(s) filed on is/are: a) acc		e Examiner.
	Applicant may not request that any objection to the	drawing(s) be held in abeyance. S	ee 37 CFR 1.85(a).
11)	Replacement drawing sheet(s) including the correct The oath or declaration is objected to by the Ex		•
Priority (under 35 U.S.C. § 119		
a)	Acknowledgment is made of a claim for foreign All b) Some * c) None of: 1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority application from the International Bureau See the attached detailed Office action for a list	ts have been received. ts have been received in Applica rity documents have been recei u (PCT Rule 17.2(a)).	ation No ved in this National Stage
Attachmen	• •		
2) Notic 3) Infor	ce of References Cited (PTO-892) ce of Draftsperson's Patent Drawing Review (PTO-948) mation Disclosure Statement(s) (PTO-1449 or PTO/SB/08) er No(s)/Mail Date	4) Interview Summa Paper No(s)/Mail 5) Notice of Informal 6) Other:	

U.S. Patent and Trademark Office PTOL-326 (Rev. 7-05) Art Unit: 1756

DETAILED ACTION

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 2. Claims 1-2, 4, 7-20, are rejected under 35 U.S.C. 102(b) as being anticipated by U.S. Patent No. 6,388,736 (Smith et al., hereinafter referred to as Smith).

Smith, in col 3, lines 54-67, in col 4, lines 1-20, and lines 53-67, in col 6, lines 35-67, in col 7, lines 1-24, in col 8, lines 5-27, in col 9, lines 42-56, in col 10, lines 38-41, in col 12, lines 19-26, discloses an imaging method (lithographic process) of forming a resist pattern (relief pattern) on a substrate using a phase shifting mask, wherein the mask includes a plurality of first and second phase shifting transparent regions surrounding a feature in a continuous manner (spacing between patterns are small), opaque regions (0% transmission regions, adjacent and/or not adjacent the feature patterns, random features of 0% and 100% transmission of varying thicknesses), and the phase shift transparent regions are placed close to each other allowing phase shifting of 0° and 180° relative to each other (phase shift regions and the pattern feature), illuminating the mask to form the corresponding patterns on the substrate (claims 1, 8-9, 10-12, 13, 17-20). Smith, in col 10, lines 66-67, in col 11, lines 1-5, discloses a silicon dioxide substrate (claims 2, and 14). Smith, in col 1, lines 13-28, discloses that the pattern formed is a circuit pattern (claims 4, and 15). Smith, in col 6,

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lines 41-45, discloses that the phase shifting mask is a chromeless phase shifting mask (claims 7, and 16).

Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. Claims 3, 5-6, are rejected under 35 U.S.C. 103(a) as being unpatentable over U.
- S. Patent No. 6,388,736 (Smith et al., hereinafter referred to as Smith) in view of U. S. Patent Application Publication No. 2004/0013948 (Lin et al., herein after referred to as Lin).

Smith in col, 1, lines 13-24, and in col 3, lines 65-67, discloses an imaging method of forming circuit patterns (includes metal lines patterns) on a photosensitive material coated substrate (claim 6).

The difference between the claims and Smith is that Smith does not disclose that the photosensitive layer is a positive photoresist layer (claim 3). Smith does not disclose that the photosensitive layer is a negative photoresist layer (claim 5).

Lin, in [0002], and [0024], discloses a photolithographical method of performing exposure on a positive or a negative photoresist (photosensitive material) coated wafer so as to transfer equal or complementary patterns of the mask to the photosensitive material (claims 3, and 5).

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Therefore, it would be obvious to a skilled artisan to modify Smith by employing a positive or a negative photoresist material as the photosensitive material as suggested by Lin because Smith, in col 10, lines 66-67, in col 11, lines 1-5, discloses that the illumination process can be performed on a photosensitive material or resist material via a mask pattern, wherein the resist material enables pattern delineation and creation of masking apertures.

Conclusion

5. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Daborah Chacko-Davis whose telephone number is (571) 272-1380. The examiner can normally be reached on M-F 9:30 - 6:00. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Mark F Huff can be reached on (571) 272-1385. The fax phone number for the organization where this application or proceeding is assigned is (571) 273-8300. Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

dcd

March 3, 2006.

JOHN^A. MCPHERSON PRIMARY EXAMINER